

Technical Data Sheet

Date Revision 04/07/2002	Révision 0
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Material : Our / Reference

4886ZAL

POUDMET Solder powder

SnCu1

Tin-copper powder, air atomised, spheroid shape

Inspection Characteristic	Unit	Lower Limiting Value	Upper Limiting Value	Desired Value	Indicative Value	Méthode
Physical						
Physical analysis :						
Sieve analysis ISO 4497 residue :						
> 75 µm	%		0,50			IN.V.1008
75 / 45 µm	%	5,00	15,00			IN.V.1008
45 / 25 µm	%	15,00				IN.V.1008
< 25 µm	%		70,00			IN.V.1008
Apparent density ISO 3923/1 - 5,0 mm	g/cm3	3,00	4,00			IN.V.1010
Chemical						
Chemical analysis :						
Tin (Sn) : Balance %						
Copper (Cu)	%	0,70000	1,30000			
Hydrogen Loss ISO 4491/2	%		0,200			IN.V.1134

FDS : Etain et alliages d'étain

All statements, technical information and recommendations herein are based on tests and data which our Company believes to be currently reliable. The accuracy or completeness thereof is not guaranteed and no warranty of any kind is made with respect thereto. Product characteristics may change due to technical development and / or improvement of production methods.

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